

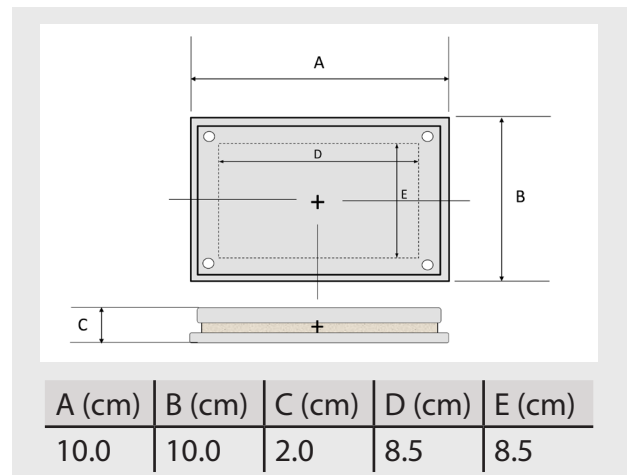
MPG PowerBlock50 Series 200 Beta

Description

The MPG PowerBlock structure is designed and built as a solid state thermoelectric system to convert heat to electricity in extreme operating temperatures at high efficiencies of up to 12%. The system consists of MicroPower Series 200 modules built with high performing PbTe and TAGS based materials produced using MicroPower Global's proprietary crystal growth and device manufacturing technologies.

Features

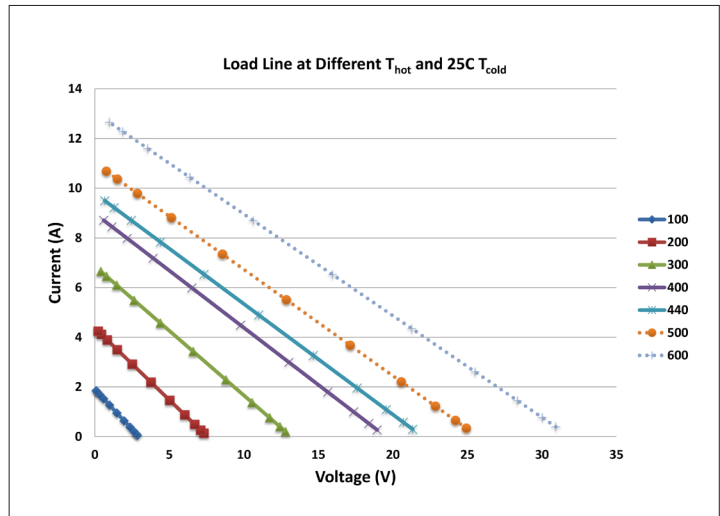
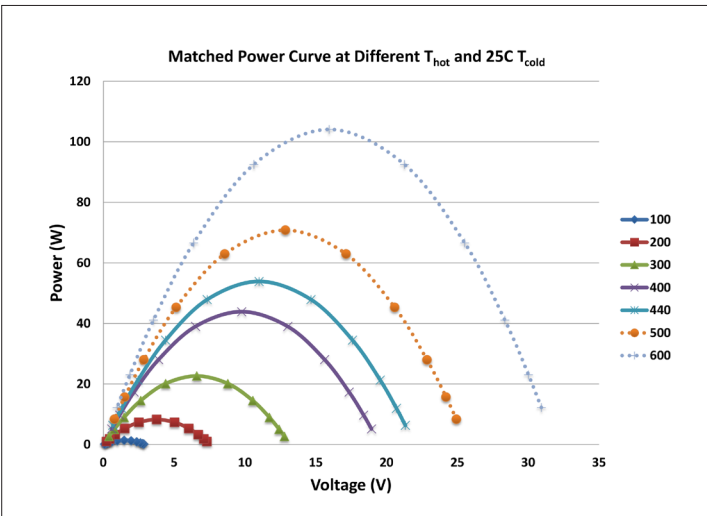
- Produces up to 50 watts at $\sim 400^{\circ}\text{C } \Delta T$
- Operates in extreme temperatures – see notes
- Maximum Power potential up to 110 watts
- Rugged and durable encasement
- Sealed with high temperature ceramic
- Designed and manufactured in the USA



Applications

- Portable power generator
- Cooking appliances
- Camp stoves
- Personal Heaters
- Fireplaces, stoves and furnaces
- Cathodic protection
- Power Beaming
- Water Heaters
- Vehicle Engine Heaters
- Engine exhaust powered alternator replacement
- Industrial waste heat recovery in refineries, foundries, glass, steel and cement plants
- Power generation from bio waste and trash incinerators
- Thermoelectric solar power generators
- Wood burning stoves
- Geothermal

Parameter	Conditions	Typical	Units
Power	$T_h=440^{\circ}\text{C}, T_c=25^{\circ}\text{C}$ @ matched load	50	Watts
Voltage	$T_h=440^{\circ}\text{C}, T_c=25^{\circ}\text{C}$ @ open circuit	21.3	Volts
	$T_h=440^{\circ}\text{C}, T_c=25^{\circ}\text{C}$ @ matched load	10.7	Volts
Internal Resistance	$T_h=440^{\circ}\text{C}, T_c=25^{\circ}\text{C}$	2.5	Ohms
	$T=25^{\circ}\text{C}$	1.5	Ohms
Current	$T_h=440^{\circ}\text{C}, T_c=25^{\circ}\text{C}$ @ matched load	4.8	Amps
	$T_h=440^{\circ}\text{C}, T_c=25^{\circ}\text{C}$ @ short circuit	9.5	Amps



Topic	Notes
Testing and Validation	<ul style="list-style-type: none"> • PowerBlocks have received bench testing consisting of resistance and mechanical checks. • Test modules have received bench testing consisting of temperature cycles to $300^{\circ}\text{C T}_{\text{hot}}$ at $25^{\circ}\text{C T}_{\text{cold}}$ • Base material chips have received bench testing to $440^{\circ}\text{C T}_{\text{hot}}$ at $25^{\circ}\text{C T}_{\text{cold}}$ • High temperature performance based upon empirical test data • High temperature electrical connections (up to 700°C) are implemented providing better performance stability over multiple heat cycles and sustained high temperatures
Mechanical Interface	<ul style="list-style-type: none"> • Stainless steel on hot side, other materials may be used, i.e., carbon composite, titanium, copper and others • Hot side exposure to radiant, conductive or convective heat source should be limited to the area defined in the size diagram as D and E boundaries • Modules' hot side should not be exposed to temperatures of $>600^{\circ}\text{C}$ • Aluminum on cold side, various heat exchange mechanism may be used, i.e., heat sink, liquid cooled block and others • Maximum cold side temperature should not exceed 120°C • Orientation: External connectors tied to cold side • Positive normal compression required at all times with stress relief at temperature • Hot Side: Recommend use of high temperature interface (e.g. Grafoil sheet) • Cold Side: Recommend use of thermal paste
Electrical Connection	<ul style="list-style-type: none"> • High temperature wire with male quick connect terminals • All terminals attached on cold side plates

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